

SPICE Device Model Si4599DY Vishay Siliconix

N- and P-Channel 40-V (D-S) MOSFET

CHARACTERISTICS

- N- and P-Channel Vertical DMOS
- Macro Model (Subcircuit Model)
- Level 3 MOS

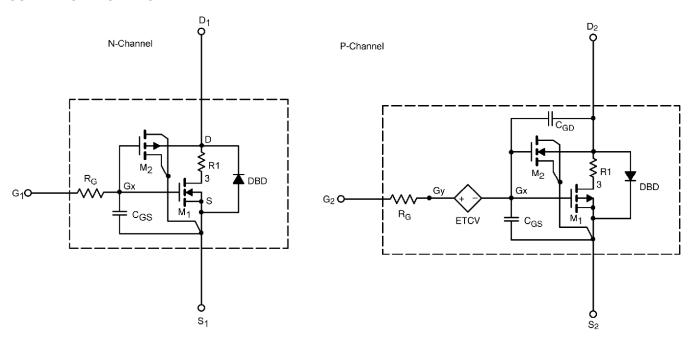
- Apply for both Linear and Switching Application
- Accurate over the 55 °C to 125 °C Temperature Range
- Model the Gate Charge, Transient, and Diode Reverse Recovery Characteristics

DESCRIPTION

The attached spice model describes the typical electrical characteristics of the n- and p-channel vertical DMOS. The subcircuit model is extracted and optimized over the - 55 $^{\circ}\text{C}$ to 125 $^{\circ}\text{C}$ temperature ranges under the pulsed 0 V to 10 V gate drive. The saturated output impedance is best fit at the gate bias near the threshold voltage.

A novel gate-to-drain feedback capacitance network is used to model the gate charge characteristics while avoiding convergence difficulties of the switched $C_{\rm gd}$ model. All model parameter values are optimized to provide a best fit to the measured electrical data and are not intended as an exact physical interpretation of the device.

SUBCIRCUIT MODEL SCHEMATIC



This document is intended as a SPICE modeling guideline and does not constitute a commercial product data sheet. Designers should refer to the appropriate data sheet of the same number for guaranteed specification limits.

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SPECIFICATIONS (T _J = 25 °C	UNLESS OT	THERWISE NOTED)				
Parameter	Symbol	Test Condition		Simulated Data	Measured Data	Unit
Static						
Gate Threshold Voltage	V _{GS(th)}	$V_{_{DS}}=V_{_{GS}},\ I_{_{D}}=250\ \mu A$	N-Ch	1.8		V
		$V_{_{DS}}=\ V_{_{GS}},\ I_{_{D}}=$ - 250 μA	P-Ch	1.5		
Drain-Source On-State Resistance ^a		$V_{_{GS}} = 10 \text{ V}, I_{_{D}} = 5 \text{ A}$	N-Ch	0.029	0.0295	Ω
	R _{DS(on)}	$V_{gs} = -10 \text{ V}, I_{D} = -5 \text{ A}$	P-Ch	0.038	0.037	
		$V_{gs} = 4.5 \text{ V}, I_{D} = 4 \text{ A}$	N-Ch	0.0352	0.0355	
		$V_{gs} = -4.5 \text{ V}, I_{d} = -4 \text{ A}$	P-Ch	0.051	0.050	
Forward Transconductance ^a		$V_{DS} = 15 \text{ V}, I_{D} = 5 \text{ A}$	N-Ch	13	22	S
	g_{\scriptscriptstylefs}	$V_{DS} = -15 \text{ V}, I_{D} = -5 \text{ A}$	P-Ch	13	14	
Diode Forward Voltage ^a	V _{SD}	I _s = 2 A, V _{GS} = 0 V	N-Ch	0.71	0.78	V
		I _s = - 2 A, V _{GS} = 0 V	P-Ch	0.76	- 0.76	
Dynamic ^b	-		-	-		-
Input Capacitance	C _{iss}		N-Ch	641	640	pF
		N-Channel	P-Ch	965	970	
Output Capacitance	C _{oss}	$V_{DS} = 20 \text{ V}, V_{GS} = 0 \text{ V}, f = 1 \text{ MHz}$	N-Ch	72	73	
		$V_{DS} = -20 \text{ V}, V_{GS} = 0 \text{ V}, f = 1 \text{ MHz}$	P-Ch	114	120	
Reverse Transfer Capacitance			N-Ch	34	41	
	C_{rss}		P-Ch	92	95	
Total Gate Charge		$V_{DS} = 20 \text{ V}, V_{GS} = 10 \text{ V}, I_{D} = 5 \text{ A}$	N-Ch	10	11.7	
	Q_g	$V_{DS} = -20 \text{ V}, V_{GS} = -10 \text{ V}, I_{D} = -5 \text{ A}$	P-Ch	19	25	
			N-Ch	5.1	5.3	
		N. Channel	P-Ch	10	11.8	nC
Gate-Source Charge	Q_{gs}	N-Channel $V_{DS} = 20 \text{ V}, V_{GS} = 4.5 \text{ V}, I_{D} = 5 \text{ A}$	N-Ch	1.9	1.9	
		P-Channel		3	3	
Gate-Source Charge		$V_{_{DS}} = -20 \text{ V}, \ V_{_{GS}} = -4.5 \text{ V}, \ I_{_{D}} = -5 \text{ A}$	N-Ch	1.7	1.7	
	Q_{gs}		P-Ch	5.2	5.2	

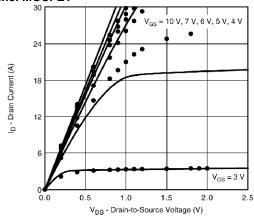
a. Pulse test; pulse width \leq 300 μ s, duty cycle \leq 2 %. b. Guaranteed by design, not subject to production testing.

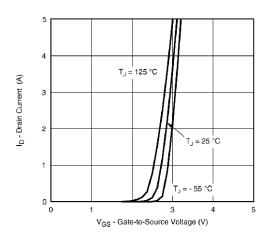


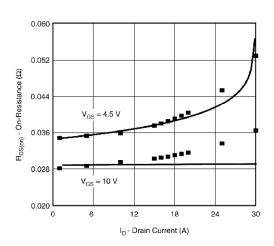
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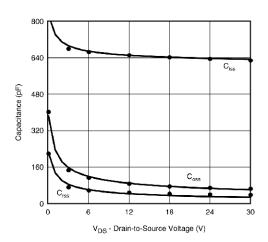
COMPARISON OF MODEL WITH MEASURED DATA (T, = 25 °C UNLESS OTHERWISE NOTED)

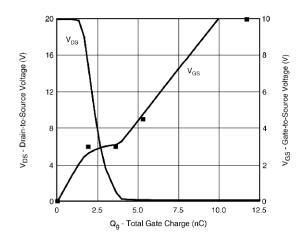
N-Channel MOSFET

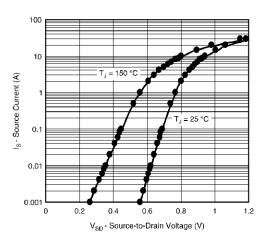












Note: Dots and squares represent measured data.

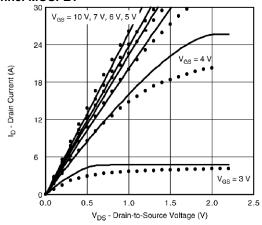
SPICE Device Model Si4599DY

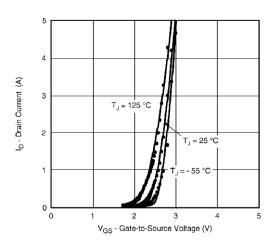
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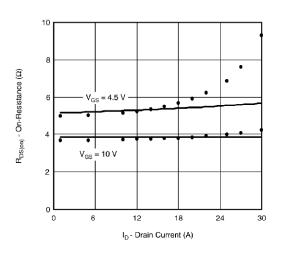


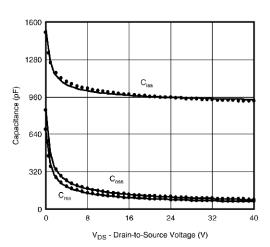
COMPARISON OF MODEL WITH MEASURED DATA (T_J = 25 °C UNLESS OTHERWISE NOTED)

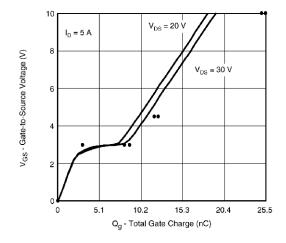
P-Channel MOSFET

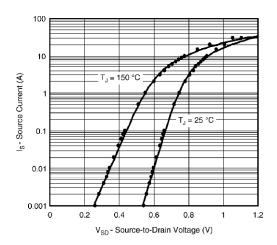












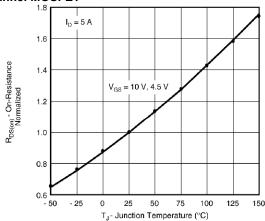
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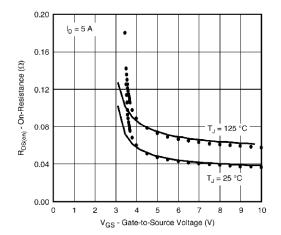


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COMPARISON OF MODEL WITH MEASURED DATA (T_J = 25 °C UNLESS OTHERWISE NOTED)

P-Channel MOSFET







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Revision: 18-Jul-08

Document Number: 91000 www.vishay.com